阅读申明

- 1.本站收集的数据手册和产品资料都来自互联网,版权归原作者所有。如读者和版权方有任何异议请及时告之,我们将妥善解决。
- 2.本站提供的中文数据手册是英文数据手册的中文翻译,其目的是协助用户阅读,该译文无法自动跟随原稿更新,同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。
- 3.本站提供的产品资料,来自厂商的技术支持或者使用者的心得体会等,其内容可能存在描 叙上的差异,建议读者做出适当判断。
- 4.如需与我们联系,请发邮件到marketing@iczoom.com,主题请标有"数据手册"字样。

Read Statement

- 1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.
- 2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.
- 3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.
- 4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets".

MAGX-002731-100L00





GaN HEMT Pulsed Power Transistor 2.7 - 3.1 GHz, 100W Peak, 500us Pulse, 10% Duty Cycle

Production V1 23 Aug 11

Features

- GaN depletion mode HEMT microwave transistor
- Common source configuration
- Broadband Class AB operation
- Thermally enhanced Cu/Mo/Cu package
- **RoHS Compliant**
- +50V Typical Operation
- MTTF of 114 years (Channel Temperature < 200°C)

Application

Civilian and Military Pulsed Radar



Product Description

The MAGX-002731-100L00 is a gold metalized matched Gallium Nitride (GaN) on Silicon Carbide RF power transistor optimized for civilian and military radar pulsed applications between 2700 - 3100 MHz. Using state of the art wafer fabrication processes, these high performance transistors provide high gain, efficiency, bandwidth, ruggedness over a wide bandwidth for today's demanding application needs. The MAGX-002731-100L00 is constructed using a thermally enhanced Cu/Mo/Cu flanged ceramic package which provides excellent thermal performance. High breakdown voltages allow for reliable and stable operation in extreme mismatched load conditions unparalleled with older semiconductor technologies.

Typical RF Performance

Freq. (MHz)	Pin (W	Pout (W Peak)	Gain (dB)	ld-Pk (A)	Eff (%)
2700	7	109	12	4.2	51
2900	7	112	12	4.4	51
3100	7	109	12	4.2	52

Typical RF performance measured in M/A-COM RF test fixture. Devices tested in common source Class-AB configuration as follows: Vdd=50V, Idq=500mA (pulsed), F=2.7-3.1 GHz, Pulse=500us, Duty=10%.

Ordering Information

MAGX-002731-100L00 100W GaN Power Transistor MAGX-002731-SB2PPR **Evaluation Fixture**

ADVANCED: Data Sheets contain information regarding a product M/A-COM Technology

Solutions is considering for development. Performance is based on target specifications, simulated results, and/or prototype measurements. Commitment to develop is not guaranteed. PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology

Solutions has under development. Performance is based on engineering tests. Specifications are

typical. Mechanical outline has been fixed. Engineering samples and/or test data may be avail-

able. Commitment to produce in volume is not guaranteed.

• North America Tel: 800.366.2266 / Fax: 978.366.2266

Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300

Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298 Visit www.macomtech.com for additional data sheets and product information.

M/A-COM Technology Solutions and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.

MAGX-002731-100L00



GaN HEMT Pulsed Power Transistor 2.7 - 3.1 GHz, 100W Peak, 500us Pulse, 10% Duty Cycle

Production V1 23 Aug 11

Absolute Maximum Ratings Table (1, 2, 3)

")
+65V
-8 to 0V
7100 mA Pk
+34 dBm
200 °C
128W
0.9 °C/W
-40 to +95C
-65 to +150C
See solder reflow profile
50 V
>250 V
MSL1

⁽¹⁾ Operation of this device above any one of these parameters may cause permanent damage.

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units
DC CHARACTERISTICS						
Drain-Source Leakage Current	V _{GS} = -8V, V _{DS} = 175V	I _{DS}	-	-	6	mA
Gate Threshold Voltage	V _{DS} = 5V, I _D = 15.0mA	V _{GS (th)}	-5	-3	-2	V
Forward Transconductance	$V_{DS} = 5V, I_{D} = 3.5 mA$	G_{M}	2.5	-	-	S
DYNAMIC CHARACTERISTICS						
Input Capacitance	Not applicable—Input internally matched	C_{GS}	N/A	N/A	N/A	pF
Output Capacitance	$V_{DS} = 50V, \ V_{GS} = -8V, F = 1MHz$	C _{DS}	ı	30.3	35.4	pF
Feedback Capacitance	$V_{DS} = 50V, \ V_{GS} = -8V, F = 1MHz$	C_GD	-	2.8	5.4	pF

⁽²⁾ Channel temperature directly affects a device's MTTF. Channel temperature should be kept as low as possible to maximize lifetime.

⁽³⁾ For saturated performance it recommended that the sum of (3*Vdd + abs(Vgg)) <175

[•] North America Tel: 800.366.2266 / Fax: 978.366.2266

[•] Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300 Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298

Visit www.macomtech.com for additional data sheets and product information.



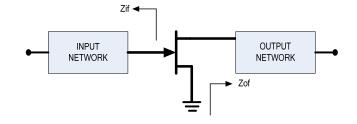
Production V1 23 Aug 11

Electrical Specifications: T_C = 25 ± 5°C (Room Ambient)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units
RF FUNCTIONAL TESTS Vdd=50V, Idq=500mA (pulsed), F=2.7—3.1 GHz, Pulse=500us, Duty=10%						
Output Power	Pin = 7W Peak	P _{OUT}	100 10	105 10.5	-	W Peak W Ave
Power Gain	Pout = 100W Peak, 10W Ave	G _P	11.6	12.6	-	dB
Drain Efficiency	Pin = 7W Peak	η_{D}	47	53	-	%
Load Mismatch Stability	Pin = 7W Peak	VSWR-S	5:1	-	-	-
Load Mismatch Tolerance	Pin = 7W Peak	VSWR-T	10:1	-	-	-

Test Fixture Impedance

F (MHz)	Z _{IF} (Ω)	Z _{OF} (Ω)			
2700	3.5 - j7.5	3.4 + j0.4			
2900	2.7 - j5.3	4.7 - j0.8			
3100	2.0 - j4.1	2.5 - j1.7			

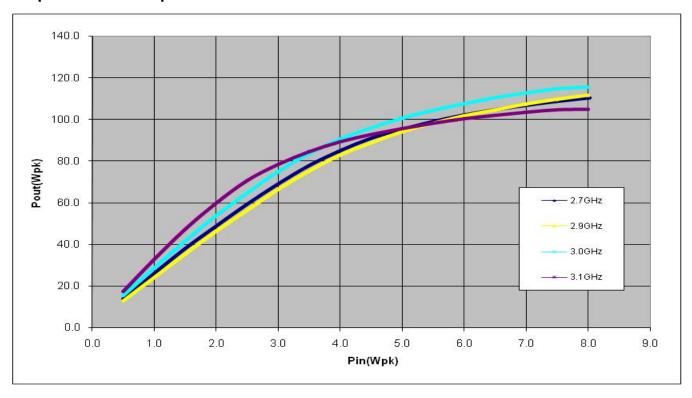


- Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300 Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298



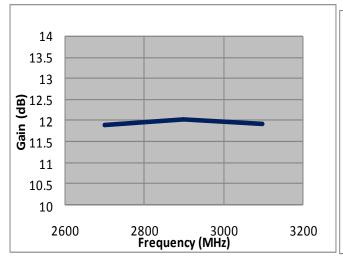
Production V1 23 Aug 11

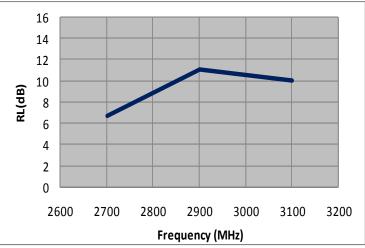
RF Power Transfer Curve at 50V Drain Bias, Idq=0.5A Output Power vs. Input Power



Gain vs. Frequency 50V Drain Bias, Idq=0.5A

Return Loss vs. Frequency 50V Drain Bias, Idq=0.5A





4

ADVANCED: Data Sheets contain information regarding a product M/A-COM Technology Solutions is considering for development. Performance is based on target specifications, simulated results, and/or prototype measurements. Commitment to develop is not guaranteed.

PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be avail-

able. Commitment to produce in volume is not guaranteed.

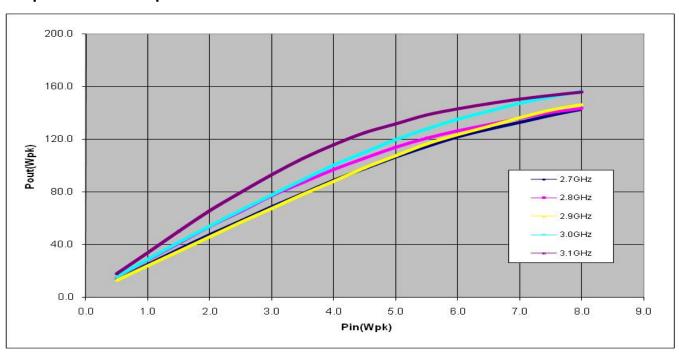
- North America Tel: 800.366.2266 / Fax: 978.366.2266
- Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298
 Visit www.macomtech.com for additional data sheets and product information.

Visit www.macomtech.com for additional data sheets and product information.

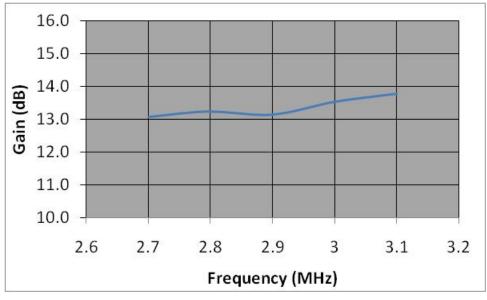


Production V1 23 Aug 11

RF Power Transfer Curve at 65V Drain Bias, Idq=0.5A Output Power vs. Input Power



Gain vs. Frequency 65V Drain Bias, Idq=0.5A



ADVANCED: Data Sheets contain information regarding a product M/A-COM Technology Solutions is considering for development. Performance is based on target specifications, simulated results, and/or prototype measurements. Commitment to develop is not guaranteed.

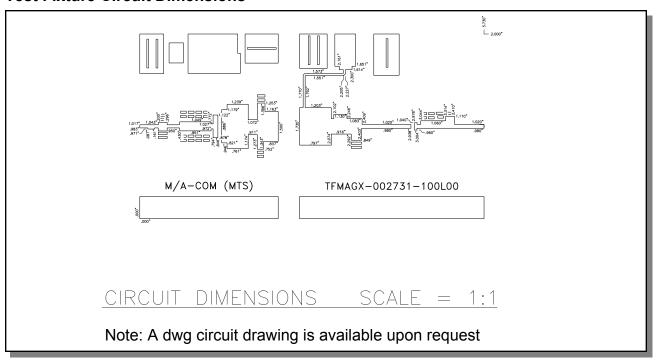
PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not guaranteed.

- North America Tel: 800.366.2266 / Fax: 978.366.2266
- Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298
 Visit www.macomtech.com for additional data sheets and product information.

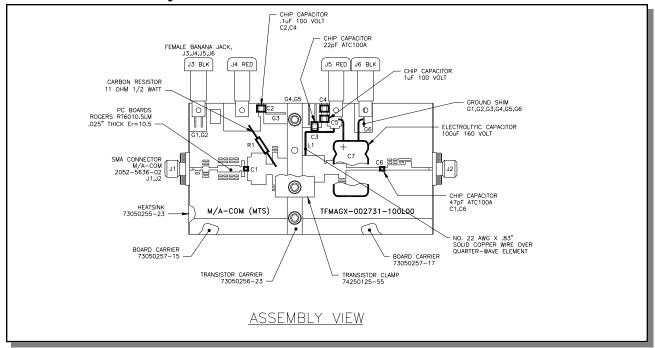


Production V1 23 Aug 11

Test Fixture Circuit Dimensions



Test Fixture Assembly



6

ADVANCED: Data Sheets contain information regarding a product M/A-COM Technology Solutions is considering for development. Performance is based on target specifications, simulated results, and/or prototype measurements. Commitment to develop is not guaranteed.

PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not guaranteed.

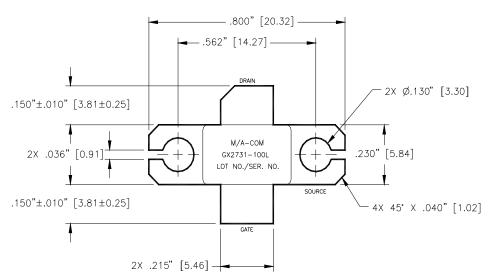
- North America Tel: 800.366.2266 / Fax: 978.366.2266
- Europe Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298
 Visit www.macomtech.com for additional data sheets and product information.

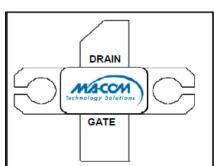
M/A-COM Technology Solutions and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.

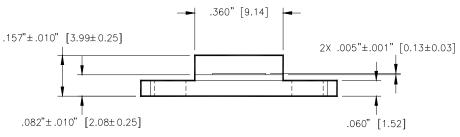


Production V1 23 Aug 11

Outline Drawings







Unless otherwise noted, tolerances are inches $\pm .005$ " [millimeters ± 0.13 mm]

CORRECT DEVICE SEQUENCING

TURNING THE DEVICE ON

- 1. Set V_{GS} to the pinch-off (V_P) , typically -5V
- 2. Turn on V_{DS} to nominal voltage (50V)
- 3. Increase V_{GS} until the I_{DS} current is reached
- 4. Apply RF power to desired level

TURNING THE DEVICE OFF

- 1. Turn the RF power off
- 2. Decrease V_{GS} down to V_P
- 3. Decrease V_{DS} down to 0V
- 4. Turn off V_{GS}

7

ADVANCED: Data Sheets contain information regarding a product M/A-COM Technology Solutions is considering for development. Performance is based on target specifications, simulated results, and/or prototype measurements. Commitment to develop is not guaranteed.

PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not guaranteed.

- North America Tel: 800.366.2266 / Fax: 978.366.2266
- **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- Asia/Pacific Tel: 81.44.844.8296 / Fax: 81.44.844.8298
 Visit www.macomtech.com for additional data sheets and product information.

M/A-COM Technology Solutions and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.